Spectra 200 (S)TEM for Materials Science

The high-throughput platform for atomic-scale materials science investigations

Combining high throughput with uncompromised resolution in imaging and spectroscopy, the Spectra 200 (S)TEM delivers the highest-quality data for all applications. With an ultrahigh-brightness X-CFEG source and a wide-gap pole piece with “room to do more,” it is the ultimate atomic-resolution materials-characterization tool.

The highest-throughput atomic-resolution STEM analysis and imaging platform

By combining an ultra-high-brightness X-CFEG source, a completely redesigned STEM detection and data processing infrastructure and a suite of energy dispersive spectroscopy (EDS) detectors optimized for different applications, the Thermo Scientific™ Spectra 200 Scanning Transmission Electron Microscope (STEM) is the highest throughput STEM analytics platform available.

High-resolution, high-contrast STEM imaging for all accelerating voltages from 30-200 kV, without the need for gun monochromation, is now straightforward due to the combination of X-CFEG with the six-fold astigmatism (A5) probe aberration corrector (S-CORR).

Adding these capabilities to our new, ultra-stable platform with advanced passive and, optionally, active vibration isolation, piezoenhanced stage, advanced software and automation modules, the Spectra 200 (S)TEM can access high-quality STEM analytics and imaging data faster and easier than ever before.

Best atomic characterization

With the new S-CORR integrated into the Spectra 200 (S)TEM, sub-Angstrom STEM imaging resolution from 60 kV to 200 kV is easily achievable. Compared to the previous generation DCOR, the S-CORR provides an order-of-magnitude improvement in optical stability of low-order aberrations, which means that you can focus on collecting meaningful data, rather than optimizing the tool.

Key Benefits

**Best atomic characterization.** Optimized STEM electron optical performance with S-CORR and ultra-sensitive detection enables the best combination of imaging and analysis in 2D and 3D.

**Optimum EDS performance.** Guaranteed by the combination of an ultra-high-brightness X-CFEG and two different detector configurations to suit the widest range of specimens and experiments.

**Most repeatable data.** Sophisticated software automation routines, such as OptiSTEM+, optimize the system to its peak performance, resulting in more repeatable, quantifiable data.

**Best in situ and dynamic research.** Fast cameras, sensitive detectors, smart software and our wide-gap lens enable in situ data acquisition with minimal compromise to resolution and analytical capabilities.

**Best environmental stability.** The redesigned enclosure and ultra-stable Spectra 200 base with passive and (optional) active vibration isolation (with iVIS) minimize external environmental influences, ensuring the highest-quality data from long-term and short-term experiments.

**Widest range of materials science research in one platform.** Our unique combination of constant power optics, ultra-high brightness X-CFEG, sensitive detection and the wide-gap pole piece ensure that even the most difficult, lightest and most sensitive materials can be characterized at the atomic scale.

The S-CORR is also capable of correcting (resolution limiting) A5 aberrations for all accelerating voltages and each Spectra 200 (S)TEM is delivered with A5 already corrected for all ordered accelerating voltages. This means that you can reproducibly access high-resolution imaging conditions without having to repeatedly tune the highest-order aberrations.
Further, each Spectra 200 (S)TEM is delivered with the new Auto S-CORR software from CEOS for fully automated correction of high-order aberrations. Optionally, the Spectra 200 (S)TEM can also be ordered with OptiSTEM+ which provides fully automated “single-click” correction of 1st and 2nd order aberrations on the specimen being investigated (with no need for a specialized specimen). This gives you an optimization tool to quickly and efficiently maintain the highest possible STEM resolution during your experiment while minimizing electron dose and any associated sample damage.

Combining S-CORR, the most powerful and easy-to-use probe corrector available, with the built-in, ultra-high-brightness X-CFEG, takes the Spectra 200 (S)TEM to the next level of high-contrast, high-quality, reproducible STEM imaging at the atomic level.

This performance is further enhanced by Thermo Scientific Velox™ Software, which seamlessly integrates drift-corrected frame imaging (DCFI) to ensure the most repeatable, high-quality, atomic-resolution imaging. Our unique integrated differential phase contrast imaging (iDPC) capability, which is fully embedded into the Velox Software, enables the study of magnetic and electrical properties as well as optimized Z-contrast, from hydrogen to uranium, at the atomic scale, replacing annular bright field (ABF) as the industry standard.

More reliable and quantitative analysis and imaging
The integrated Faraday cup provides an accurate calibration of the beam current measurement. These currents are pivotal for quantitative and reliable imaging and analysis. The Faraday cup measurement guarantees experimental repeatability on different Thermo Scientific tools.

Panther: the next generation in low dose STEM imaging
The Spectra 200 (S)TEM is equipped with an entirely new, segmented STEM detection and data infrastructure unit. The new detector geometry offers access to advanced STEM imaging capability combined with the sensitivity and detectability to measure single electrons. The entire signal chain has been optimized and tuned to provide unprecedented signal-to-noiseratio-imaging capability with extremely low probe currents (<1 pA). When combined with sensitive STEM imaging techniques, such as iDPC, and an X-CFEG capable of reproducibly producing atomic scale probes with currents less than 1 pA, new possibilities are enabled for imaging dose-sensitive samples which have typically been very difficult to characterize with a TEM.

Additionally, the completely redeveloped data processing infrastructure allows segments to be addressed independently. Therefore, multiple STEM signals containing different information about the specimen can be generated from a single scan on a single detector, resulting in less dose on the specimen.
The document provides technical highlights for a scanning transmission electron microscope (STEM). The key features are summarized as follows:

**Technical highlights**

**Source**
- X-CFEG: Ultra-high-brightness cold field emission gun with energy resolution of <0.4 eV
- Flexible high-tension range from 30 – 200 kV

**Optical column and correctors**
- Three lens condenser system with indication of convergence angle and size of illuminated area for quantitative measure of electron dose and illumination conditions
- New S-CORR provides sub-Angstrom imaging resolution at 60 kV as specification and an order of magnitude improvement in optical stability. The S-CORR corrects A5 for all accelerating voltages
- New CEOS Auto S-CORR alignment software makes probe corrector tuning easy, fast and fully automated up to and including 4th order aberrations
- Patented mechanical stacking of column modules minimizes instabilities caused by excessive deflector excitations
- Thermo Scientific ConstantPower™ Lens, designed for ultimate thermal stability in mode switches, minimizes image drift
- Low hysteresis design to minimize crosstalk between optical components for ultimate reproducibility
- Symmetric S-TWIN or X-TWIN objective lens with wide-gap pole piece design of 5.4 mm with “space to do more,” allowing the use of special holders such as heating, cooling and STM/AFM holders
- Objective aperture in the back focal plane of the objective lens for optimum TEM dark field application work

**Automatic apertures for remote control operation and reproducible recall of aperture positions during aperture change**

**Field upgradeable probe Cs-corrector (S-CORR)**

**Rotation-free imaging for easy operation and clear orientation relationship between imaging and diffraction**

**Sub-Angstrom resolution for all accelerating voltages (60-200 kV) with low specimen drift**

**Field-free imaging in TEM Lorentz mode with 2nm resolution for magnetic property studies, and option for Cs-corrected Lorentz with <1nm resolution**

**On special request: Cs-corrected field-free TEM imaging in Lorentz with <1nm resolution for magnetic property studies**

**Stage**
- Computerized 5-axis, ultra-stable specimen piezo stage for accurate recall of stored positions and tracking of the areas visited during sample navigation
- The piezo stage allows for movements as fine as 20 pm for centering of feature of interest in the field of view
- Tilt range ±40 degrees for analytical double tilt holder to orientate the maximum amount of zone axes of one crystal in polycrystalline material. With tomography holder ±70 degrees to minimize the missing wedge in 3D reconstructions
- Linear drift compensation provided by piezo stage can be used to mitigate limitations caused by thermal drift which is unavoidable during in situ heating or cooling experiments

### Table: Spectra 200 (S)TEM

<table>
<thead>
<tr>
<th></th>
<th>Energy spread</th>
<th>Information limit</th>
<th>STEM resolution</th>
</tr>
</thead>
<tbody>
<tr>
<td>Probe corrector</td>
<td>0.4 eV</td>
<td>110 pm</td>
<td>60 pm (136 pm @ 30 kV)</td>
</tr>
<tr>
<td>Uncorrected</td>
<td>0.4 eV</td>
<td>110 pm</td>
<td>164 pm</td>
</tr>
</tbody>
</table>

Note: All specifications are at 200 kV with an S-TWIN lens (unless otherwise noted).

![Figure 4. Metal Organic Framework (MOF) MIL-101 imaged with 0.5 pA of beam current in STEM with iDPC at 200 kV. The image is a single shot with a frame time of 23.5 seconds and the complex structure can be seen with 2 Å resolution. Specimen courtesy of Professor Y. Han, King Abdullah University of Science and Technology.]
Analytics and detectors

- Super-X/Dual-X EDS options, integrated software, and the Gatan Ultrafast EELS/DualEELS options together provide up to 1000 sp/s of simultaneous EDS and EELS data acquisition
- Live peak identification and background fitting during ultrafast EDS acquisition
- Symmetric EDS detector design allows for tomographic EDS using all detectors EDX detector portfolio
- EDS quantification using the Velox Software (featuring dynamic correction of holder shadowing as a function of tilt for both Super-X and Dual-X)
- Super-X: high-sensitivity, windowless EDX detector system based on patented SDD technology
  - Output count rate: up to 800 kcps
  - Energy resolution
    - ≤136 eV for Mn-Ka and 10 kcps (output)
    - ≤140 eV for Mn-Ka and 100 kcps (output)
  - 0.7 srad solid angle
  - High P/B ratio (Fiori number) >4000
  - Excellent in-hole performance (<1% hole counts)
- Dual-X: symmetric, windowless EDX detector system with high solid angle and throughput
  - Output count rate: >23 kcps/nA/detector
  - Energy resolution
    - ≤130 eV for Mn-Ka and 10 kcps (output)
    - ≤140 eV for Mn-Ka and 100 kcps (output)
  - 1.8 srad solid angle
  - P/B ratio (Fiori number) > 2000
  - Excellent in-hole performance (<1% hole counts)
  - <2.5% spurious peaks system background in EDS

Available detector options

- HAADF detector
- New Panther ultra-low noise on-axis solid stage, 8 segmented BF and ADF detectors (16 segments in total)
- Thermo Scientific Ceta™ 16M Camera (optionally with speed enhancement)
- Gatan OneView/OneView IS cameras
- Gatan energy filter series
- Electron microscope pixel array detector (EMPAD)

Software

- Differential phase contrast (DPC) STEM technique enables live measurements of intrinsic magnetic and electric fields
- Integrated DPC (dDPC) software for ultimate imaging contrast in STEM on materials across the whole periodic table. This low-dose technique expands the use cases to the materials scientist and replaces annular bright field as the technique of choice for light elements. Invaluable when applied to samples that are typically damaged under short exposures to the electron beam
- OptiSTEM+ software for single-click correction of 1st and 2nd order probe forming aberrations to deliver the ultimate STEM resolution to all users on our probe-corrected tools**
- Thermo Scientific TrueImage™ Atlas focus series software for quantitative HR-TEM applications (For more details see separate product data sheet)
- Fully digital system for remote controlled operation using the SmartCam suite
- Advanced, integrated software enables fast and simultaneous signal acquisition (up to five STEM signals)
- Smart scanning technology for high image quality in STEM

Available holders

- Single tilt holder
- Double tilt holder
- Tomography holder
- Thermo Scientific and 3rd party in situ holders
- Please ask for a list of functional holders

Other features

- Environmental enclosure to relax the acoustic and room temperature variation requirements
- Cold trap design for up to four days of operation to maximize up-time

Installation requirements

- Please contact your sales representative for a complete pre-installation requirement document

* Tilt range 30° with Super-X option.
** Ultimate performance guaranteed in combination with S-CORR probe corrector.